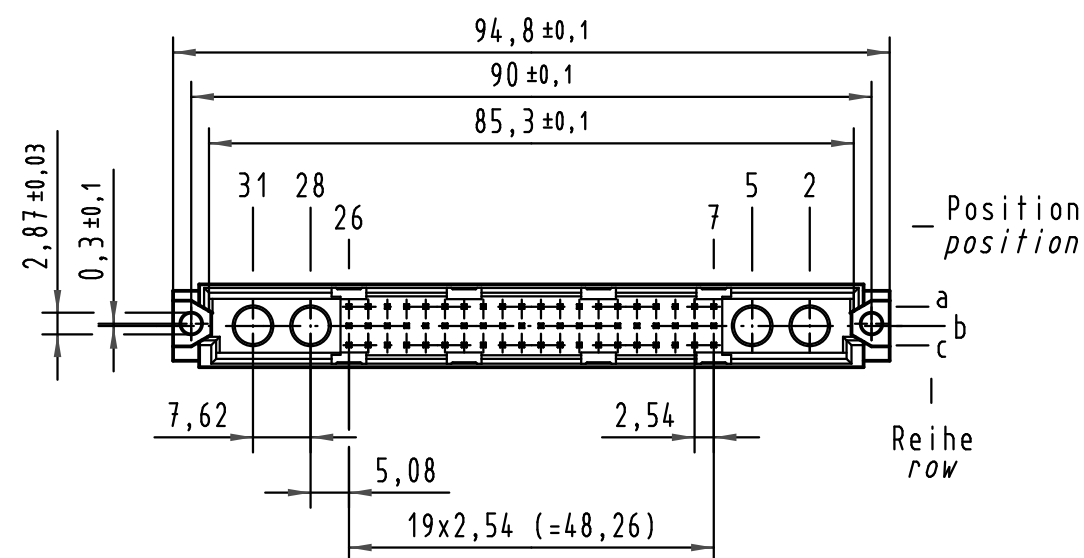
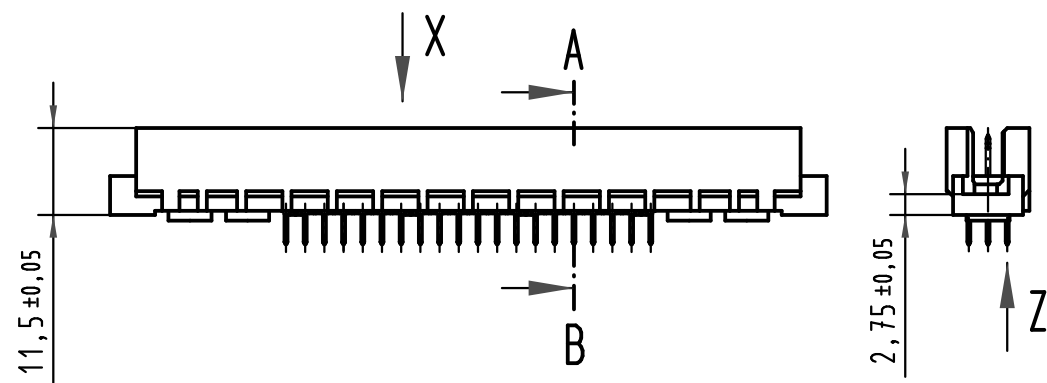
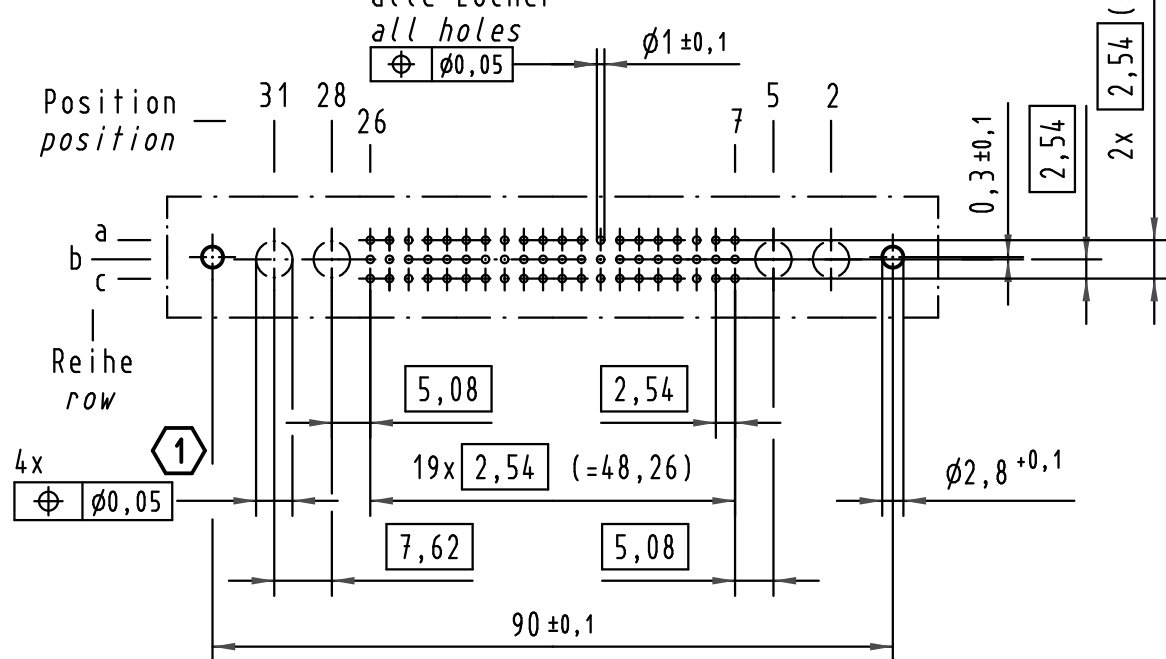
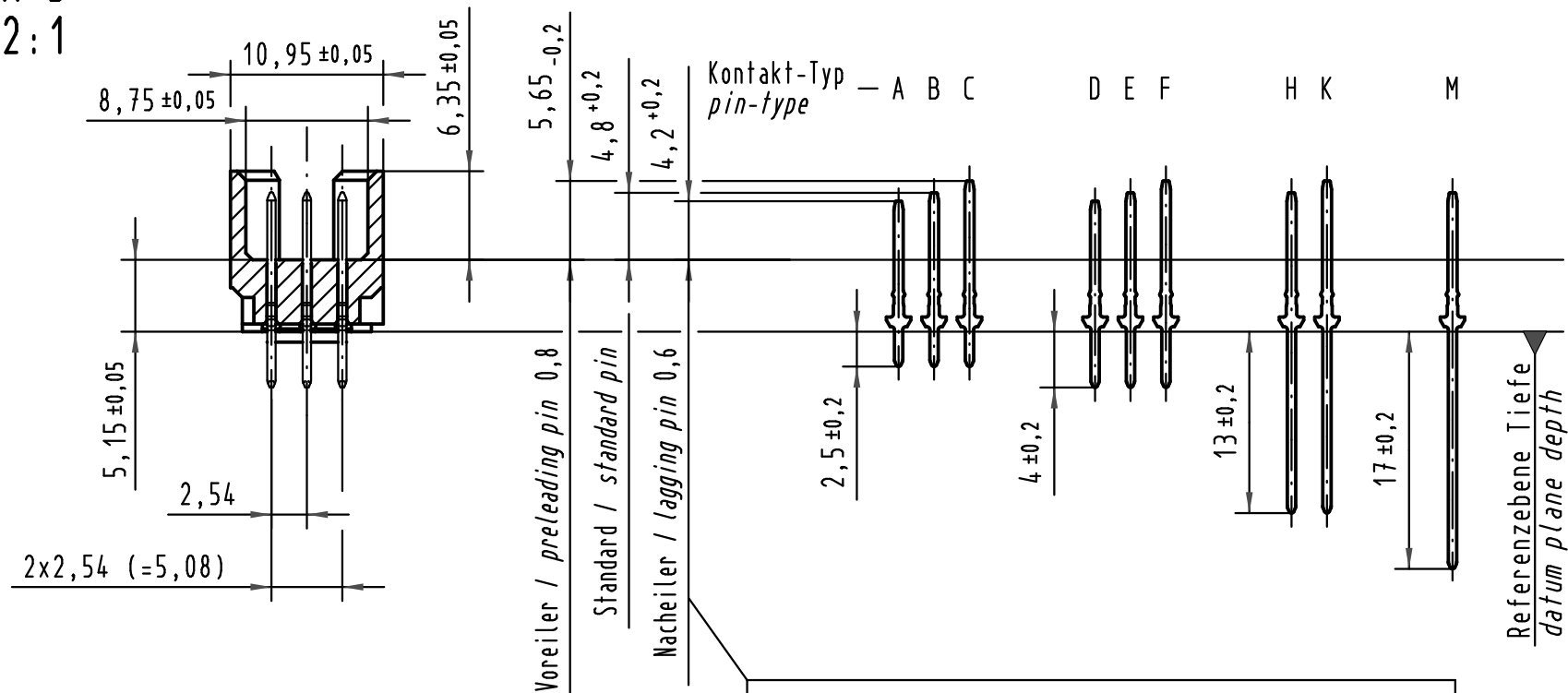


X (Lochbild) (board drillings)

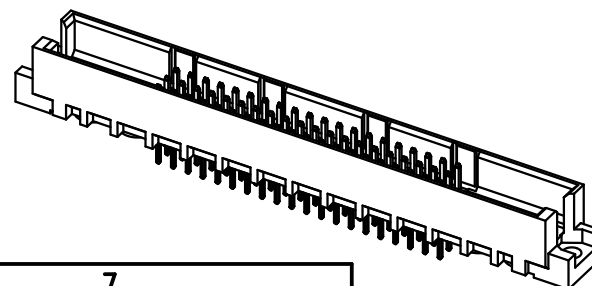
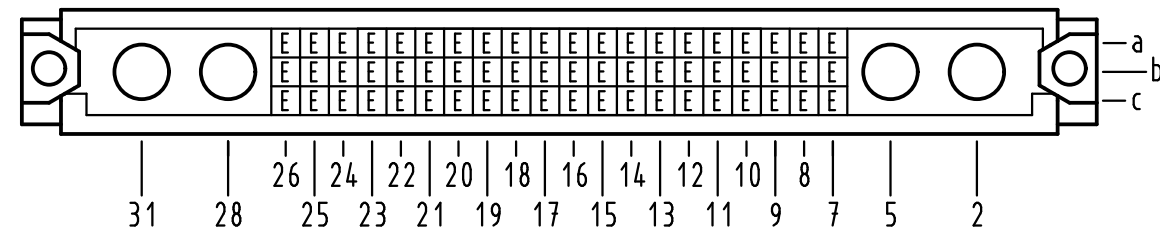


A-B 2:1



Steckbedingungen entsprechen nicht IEC 60603-2
mating conditions are not acc. to IEC 60603-2

X Kontaktbelegung contact loading

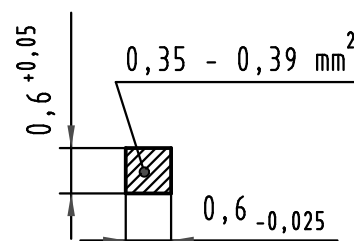


1 Lochdurchmesser ist auf den jeweiligen Kontakt abzustimmen
hole diameter is to be coordinated with the respective contact

09 73 160 6903	2	Au flash over PdNi over Ni
Bestell-Nr. part-No.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

Z 10:1

Querschnitt der Lötanschlüsse:
cross-section of solder terminations:



 All Dimensions in mm Original Size DIN A 3			Techn. Character.				Nicht tolerierte Maßel Free size tolerances IEC 60603-2			
				Dat.	Name	Maßstab/Scale 1 : 1 2 : 1 10 : 1	type M inverse 60+4 Messerleiste Einlöt 4,0 male connector solder 4,0			
			Detail.	09.02.05	Hil					
			Insp.	09.02.05	kfoe					
			Stand.							
35548	16.07.09	hsv	HARTING Electronics GmbH & Co. KG					TB 09 73 160 x903		Blatt/ page /
32541			D-32339 ESPELKAMP							
Mod.	Dat.	Name					Sub.			

